

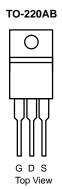
N-Channel 130 V (D-S) 175 °C MOSFET

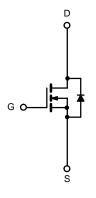
PRODUC	T SUMMARY	
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)
130	0.0033 at V _{GS} = 10 V	160 ^a

FEATURES

- TrenchFET[®] Power MOSFET
- New Package with Low Thermal Resistance
- 100 % R_g Tested







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_{C} = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	130	V			
Gate-Source Voltage		V _{GS}	± 20	v		
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I _D	160 ^a			
Continuous Drain Current $(T_J = T/5 C)$	T _C = 125 °C	'D	115 ^a	A		
Pulsed Drain Current	I _{DM}	580	~			
Avalanche Current		I _{AR}	98			
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	1500	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	Р	378 ^c	W		
	T _A = 25 °C		4.39	vv		
Operating Junction and Storage Temperature	Range	T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RA	TINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	0/00

Notes:

a. Package limited.

a. Package infined.
b. Duty cycle ≤ 1 %.
c. See SOA curve for voltage derating.
d. When mounted on 1" square PCB (FR-4 material).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	130				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 175 °C			250	l	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	160			А	
		V _{GS} = 10 V, I _D = 20 A		0.0033	0.0042		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C			0.0068	Ω	
		V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C			0.0112		
Forward Transconductancea	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	68			S	
Dynamic ^b	•						
Input Capacitance	C _{iss}			7920		pF	
Output Capacitance	C _{oss}			830			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge ^c	Qg			110	150		
Gate-Source Charge ^c	Q _{gs}	V _{DS} = 50 V, V _{GS} = 10 V, I _D = 85 A		46		nC	
Gate-Drain Charge ^c	Q _{gd}			24			
Gate Resistance	R _g		1.0		6.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			22	33		
Rise Time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{1} = 0.6 \Omega$		102	180		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 85 \text{ Å}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		53	85	ns	
Fall Time ^c	t _f			18	35		
Source-Drain Diode Ratings and Cha	aracteristics	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$					
Continuous Current	۱ _S				158		
Pulsed Current	I _{SM}				580	A	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			75	148	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		5.5	10	Α	
Reverse Recovery Charge	Q _{rr}	1		0.18	0.33	μC	

Notes:

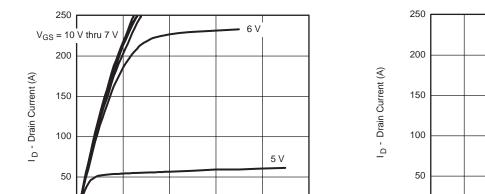
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

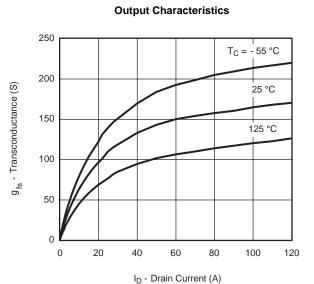
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





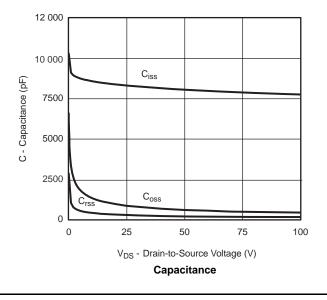
4 V

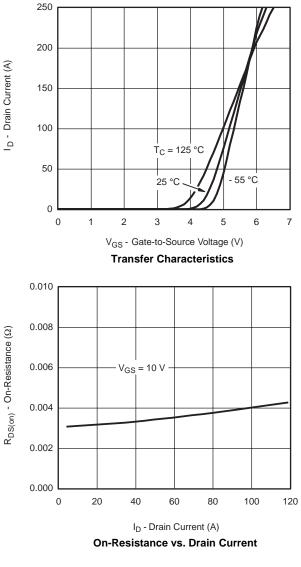
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

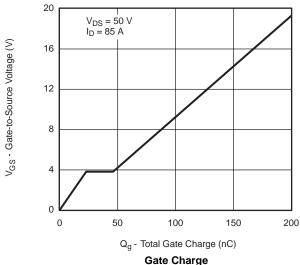


V_{DS} - Drain-to-Source Voltage

Transconductance

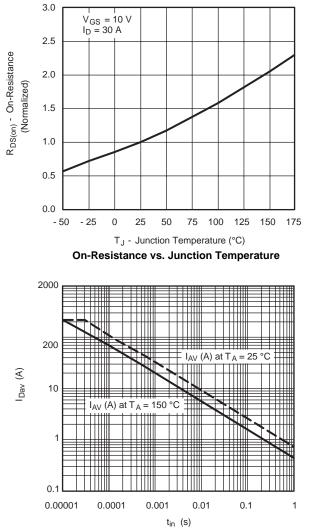




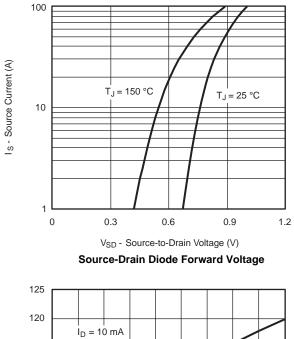


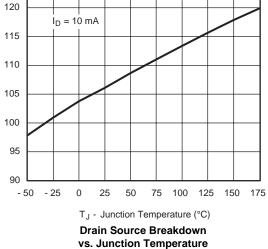
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Avalanche Current vs. Time



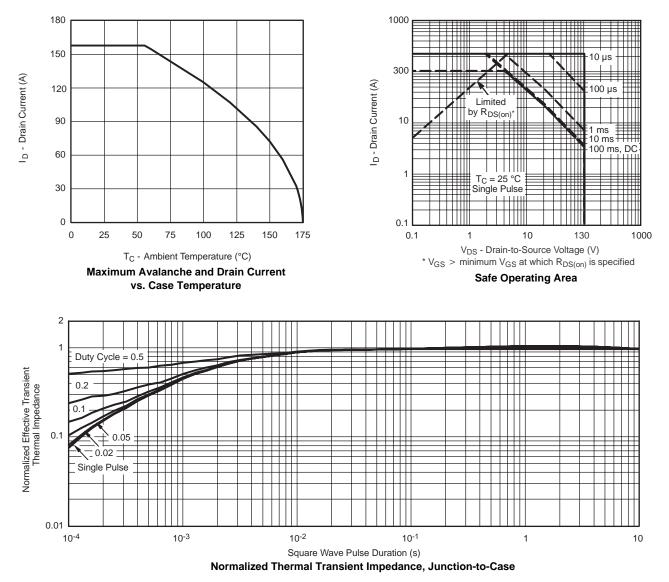


V_{(BR)DSS} (V)



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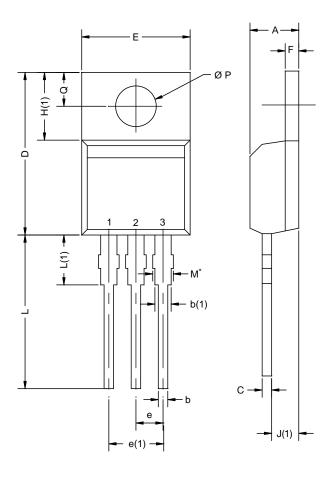
THERMAL RATINGS





Package Information www.din-tek.jp

TO-220AB



MIN.	MAX.	MIN.	MAX.
4.25	4.65	0.167	0.183
0.69	1.01	0.027	0.040
1.20	1.73	0.047	0.068
0.36	0.61	0.014	0.024
14.85	15.49	0.585	0.610
10.04	10.51	0.395	0.414
2.41	2.67	0.095	0.105
4.88	5.28	0.192	0.208
1.14	1.40	0.045	0.055
6.09	6.48	0.240	0.255
2.41	2.92	0.095	0.115
13.35	14.02	0.526	0.552
3.32	3.82	0.131	0.150
3.54	3.94	0.139	0.155
2.60	3.00	0.102	0.118
	4.25 0.69 1.20 0.36 14.85 10.04 2.41 4.88 1.14 6.09 2.41 13.35 3.32 3.54 2.60	4.25 4.65 0.69 1.01 1.20 1.73 0.36 0.61 14.85 15.49 10.04 10.51 2.41 2.67 4.88 5.28 1.14 1.40 6.09 6.48 2.41 2.92 13.35 14.02 3.32 3.82 3.54 3.94	4.254.650.1670.691.010.0271.201.730.0470.360.610.01414.8515.490.58510.0410.510.3952.412.670.0954.885.280.1921.141.400.0456.096.480.2402.412.920.09513.3514.020.5263.323.820.1313.543.940.1392.603.000.102

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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